

17W

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.: 10/647,297 Group Art Unit: 1794
Filing Date: August 26, 2003 Examiner: Hai Vo
Applicants: Hyun HUH et al.
Title: POLISHING PAD CONTAINING EMBEDDED
LIQUID MICROELEMENTS AND METHOD OF
MANUFACTURING THE SAME

Attorney Docket: 47881-000003/US

Customer Service Window
Randolph Building
401 Dulany Street
Alexandria, VA 22314
Mail Stop Amendment

October 24, 2008


AMENDMENT UNDER 37 C.F.R. § 1.111

Sir:

In response to the Office Action mailed August 19, 2008, the following remarks are respectfully submitted in connection with the above-identified application.

Amendments to the Claims begins on page 2 of this Amendment.

Remarks begin on page 5 of this Amendment.

	Claims remaining after Amendment		Highest number previously paid for		Present extra
Total	14	-	31	=	0
Independent	1	-	3	=	0